



FOR IMMEDIATE RELEASE

HDP User Group Announces Firan Technology Group as a New Member

Cave Creek, Arizona April 2, 2019. High Density Packaging (HDP) User Group is pleased to announce that Firan Technology Group Corporation (FTG) has become a member.

"FTG has consistently looked to understand and advance circuit board technology, particularly in the areas of performance and reliability. We believe that by joining the HDP user group we will be able to learn from others and contribute our knowledge within the planned projects, to the benefit of the overall industry", said Hardeep Heer, CTO, FTG Corporation.

"As one of the leading mil-spec printed circuit board suppliers, FTG is an excellent addition to the HDP User Group Membership. We look forward to FTG's participation in HDP projects and their insight into the issues and new technology being addressed.", said Marshall Andrews, Executive Director of HDP User Group.

About FTG

FTG is an aerospace and defense electronics product and subsystem supplier to customers around the globe;

FTG is a manufacturer of complex mil-spec and specialty printed circuit boards for the Avionics, Military, and Space markets for over three decades. FTG Circuits has operations in Toronto, Ontario, Chatsworth, California and a joint venture in Tianjin, China.

FTG Aerospace manufactures illuminated cockpit panels, keyboards and sub-assemblies for original equipment manufacturers of aerospace and defense equipment. FTG Aerospace has operations in Toronto, Ontario, Chatsworth, California, Fort Worth, Texas and Tianjin, China.

For more information, visit FTG at www.ftgcorp.com

About HDP User Group

HDP User Group (www.hdpug.org) is a global research and development organization based in Cave Creek Arizona, is dedicated to "reducing the costs and risks for the Electronics Manufacturing industry when using advanced electronic packaging and



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assembly". This international industry led group organizes and conducts R&D programs to address the technical issues facing the industry, including design, printed circuit board manufacturing, electronics assembly, and environmental compliance. HDP User Group maintains additional offices in Austin Texas, and Singapore.

For more information, visit HDP User Group on the Internet at www.hdpug.org or contact Darryl Reiner at darrylr@hdpug.org, phone number +1 480-951-1963